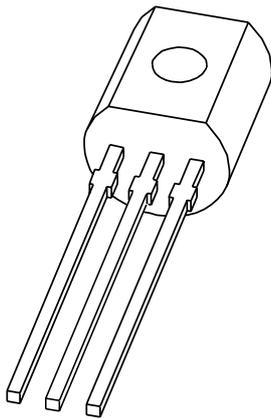


DATA SHEET



BC635; BC637; BC639 NPN medium power transistors

Product specification
Supersedes data of 1999 Apr 23

2001 Oct 10

NPN medium power transistors

BC635; BC637; BC639

FEATURES

- High current (max. 1 A)
- Low voltage (max. 80 V).

APPLICATIONS

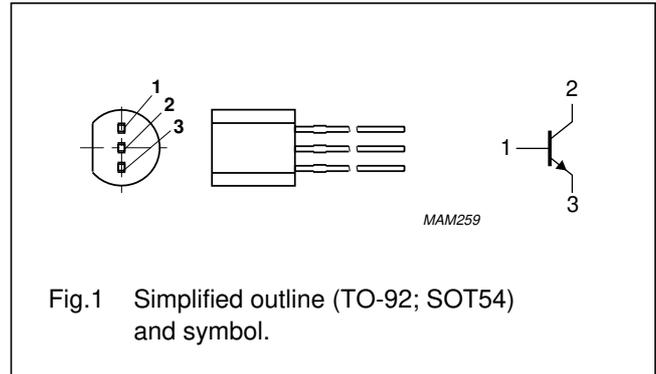
- Driver stages of audio/video amplifiers.

DESCRIPTION

NPN transistor in a TO-92; SOT54 plastic package.
 PNP complements: BC636, BC638 and BC640.

PINNING

| PIN | DESCRIPTION |
|-----|-------------|
| 1 | base |
| 2 | collector |
| 3 | emitter |



LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

| SYMBOL | PARAMETER | CONDITIONS | MIN. | MAX. | UNIT |
|------------------|-------------------------------|--------------------------|------|------|------|
| V _{CBO} | collector-base voltage | open emitter | | | |
| | BC635 | | – | 45 | V |
| | BC637 | | – | 60 | V |
| | BC639 | | – | 100 | V |
| V _{CEO} | collector-emitter voltage | open base | | | |
| | BC635 | | – | 45 | V |
| | BC637 | | – | 60 | V |
| | BC639 | | – | 80 | V |
| V _{EBO} | emitter-base voltage | open collector | – | 5 | V |
| I _C | collector current (DC) | | – | 1 | A |
| I _{CM} | peak collector current | | – | 1.5 | A |
| I _{BM} | peak base current | | – | 200 | mA |
| P _{tot} | total power dissipation | T _{amb} ≤ 25 °C | – | 0.83 | W |
| T _{stg} | storage temperature | | –65 | +150 | °C |
| T _j | junction temperature | | – | 150 | °C |
| T _{amb} | operating ambient temperature | | –65 | +150 | °C |

NPN medium power transistors

BC635; BC637; BC639

THERMAL CHARACTERISTICS

| SYMBOL | PARAMETER | CONDITIONS | VALUE | UNIT |
|---------------|---|------------|-------|------|
| $R_{th\ j-a}$ | thermal resistance from junction to ambient | note 1 | 150 | K/W |

Note

1. Transistor mounted on an FR4 printed-circuit board.

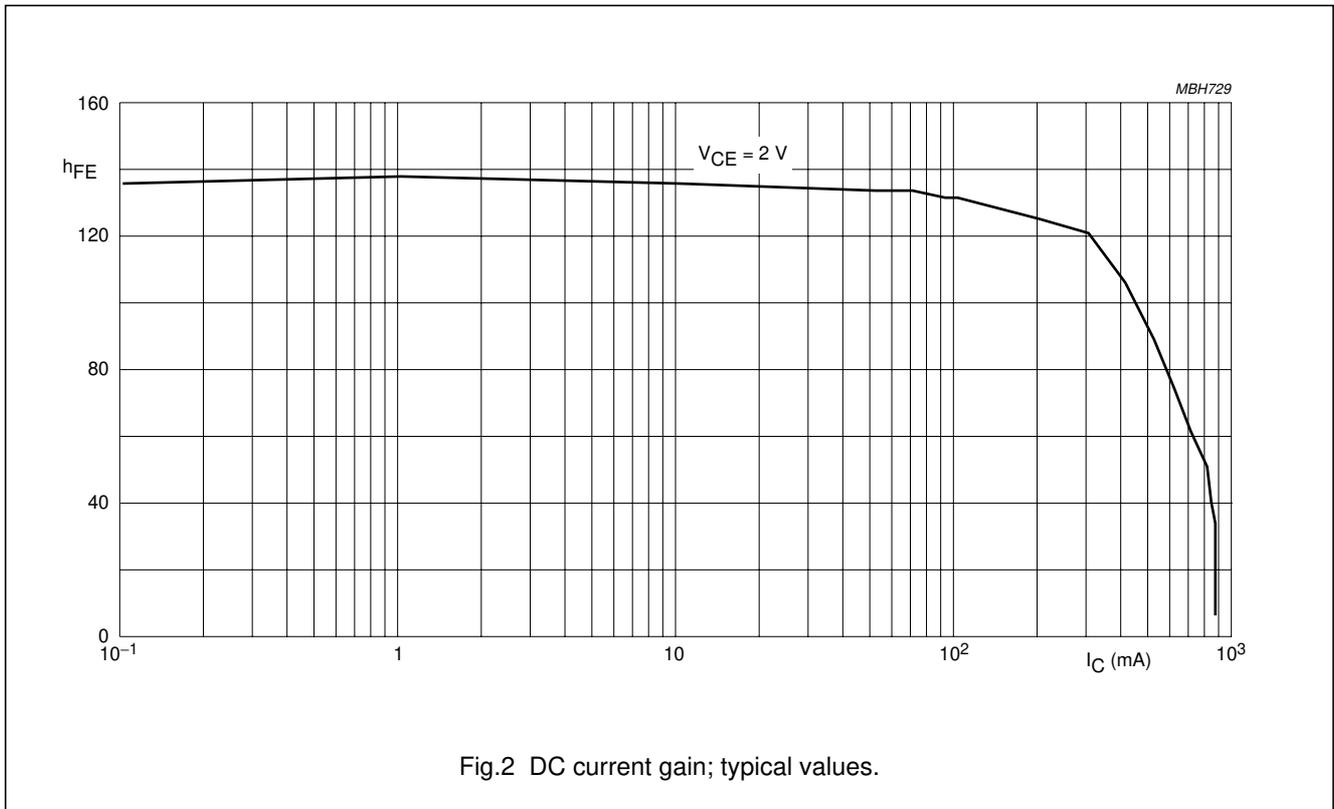
CHARACTERISTICS

$T_j = 25\text{ °C}$ unless otherwise specified.

| SYMBOL | PARAMETER | CONDITIONS | MIN. | MAX. | UNIT |
|---------------------------|---|---|-----------|------------|---------------|
| I_{CBO} | collector cut-off current | $I_E = 0; V_{CB} = 30\text{ V}$ | – | 100 | nA |
| | | $I_E = 0; V_{CB} = 30\text{ V}; T_j = 150\text{ °C}$ | – | 10 | μA |
| I_{EBO} | emitter cut-off current | $I_C = 0; V_{EB} = 5\text{ V}$ | – | 100 | nA |
| h_{FE} | DC current gain | $V_{CE} = 2\text{ V}$; see Fig.2 $I_C = 5\text{ mA}$ | 63 | – | |
| | | $I_C = 150\text{ mA}$ $I_C = 500\text{ mA}$ | 63 40 | 250 – | |
| | DC current gain BC639-10 BC635-16; BC637-16; BC639-16 | $I_C = 150\text{ mA}; V_{CE} = 2\text{ V}$; see Fig.2 | 63 100 | 160 250 | |
| V_{CEsat} | collector-emitter saturation voltage | $I_C = 500\text{ mA}; I_B = 50\text{ mA}$ | – | 500 | mV |
| V_{BE} | base-emitter voltage | $I_C = 500\text{ mA}; V_{CE} = 2\text{ V}$ | – | 1 | V |
| f_T | transition frequency | $I_C = 50\text{ mA}; V_{CE} = 5\text{ V}; f = 100\text{ MHz}$ | 100 | – | MHz |
| $\frac{h_{FE1}}{h_{FE2}}$ | DC current gain ratio of the complementary pairs | $ I_C = 150\text{ mA}; V_{CE} = 2\text{ V}$ | – | 1.6 | |

NPN medium power transistors

BC635; BC637; BC639



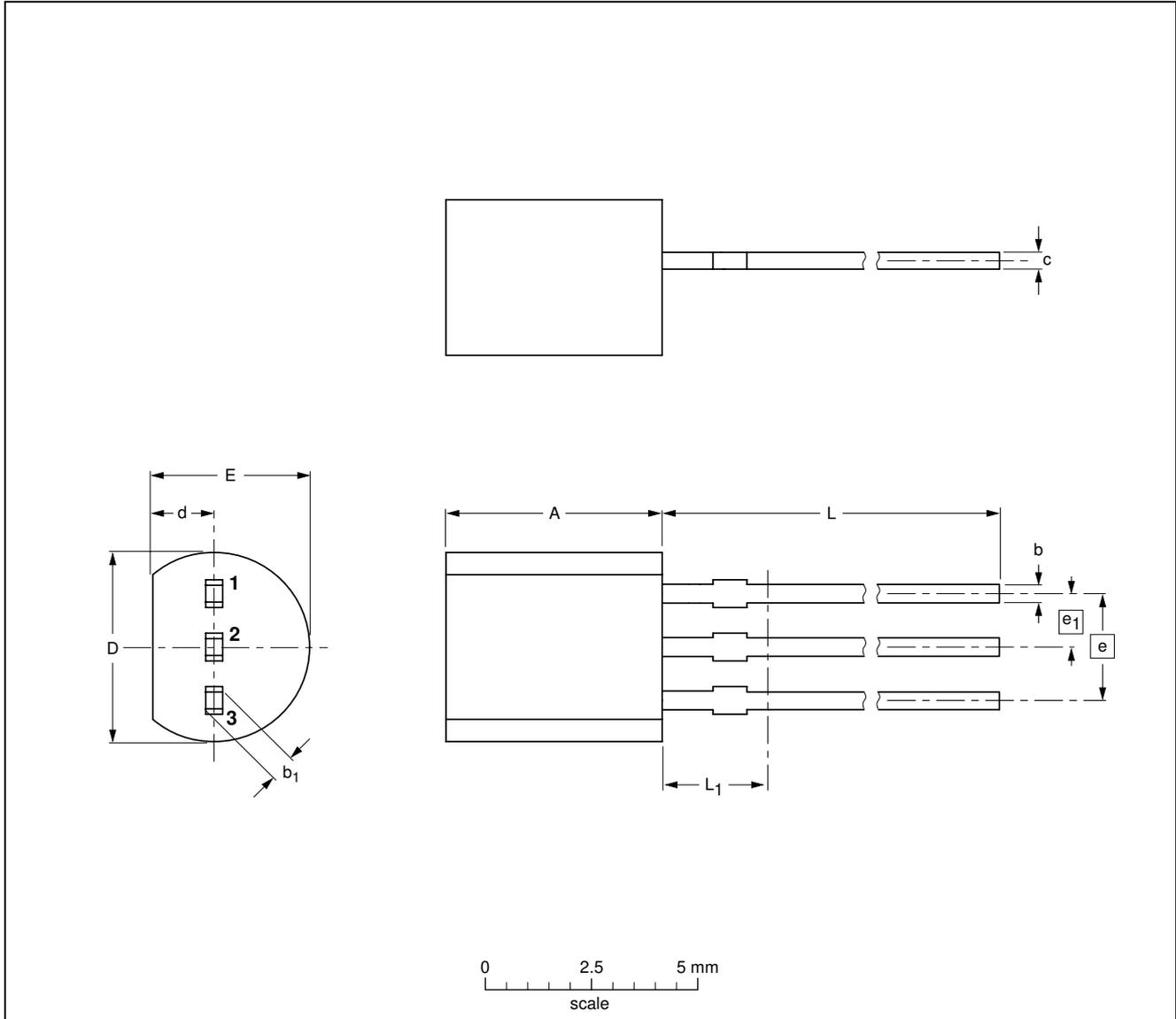
NPN medium power transistors

BC635; BC637; BC639

PACKAGE OUTLINE

Plastic single-ended leaded (through hole) package; 3 leads

SOT54



DIMENSIONS (mm are the original dimensions)

| UNIT | A | b | b ₁ | c | D | d | E | e | e ₁ | L | L ₁ ⁽¹⁾ |
|------|------------|--------------|----------------|--------------|------------|------------|------------|------|----------------|--------------|-------------------------------|
| mm | 5.2 5.0 | 0.48 0.40 | 0.66 0.56 | 0.45 0.40 | 4.8 4.4 | 1.7 1.4 | 4.2 3.6 | 2.54 | 1.27 | 14.5 12.7 | 2.5 |

Note

1. Terminal dimensions within this zone are uncontrolled to allow for flow of plastic and terminal irregularities.

| OUTLINE VERSION | REFERENCES | | | EUROPEAN PROJECTION | ISSUE DATE |
|-----------------|------------|-------|-------|---------------------|------------|
| | IEC | JEDEC | EIAJ | | |
| SOT54 | | TO-92 | SC-43 | | 97-02-28 |

NPN medium power transistors

BC635; BC637; BC639

DATA SHEET STATUS

| DATA SHEET STATUS ⁽¹⁾ | PRODUCT STATUS ⁽²⁾ | DEFINITIONS |
|----------------------------------|-------------------------------|--|
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NPN medium power transistors

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NOTES

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